

PRODUCT CHANGE NOTICE

SUBJECT: ELJ-xA, ELJ-xB, ELJ-xC Wirewound Chip Inductors Going Lead-free (NoPb)

Date: 12-04-2012

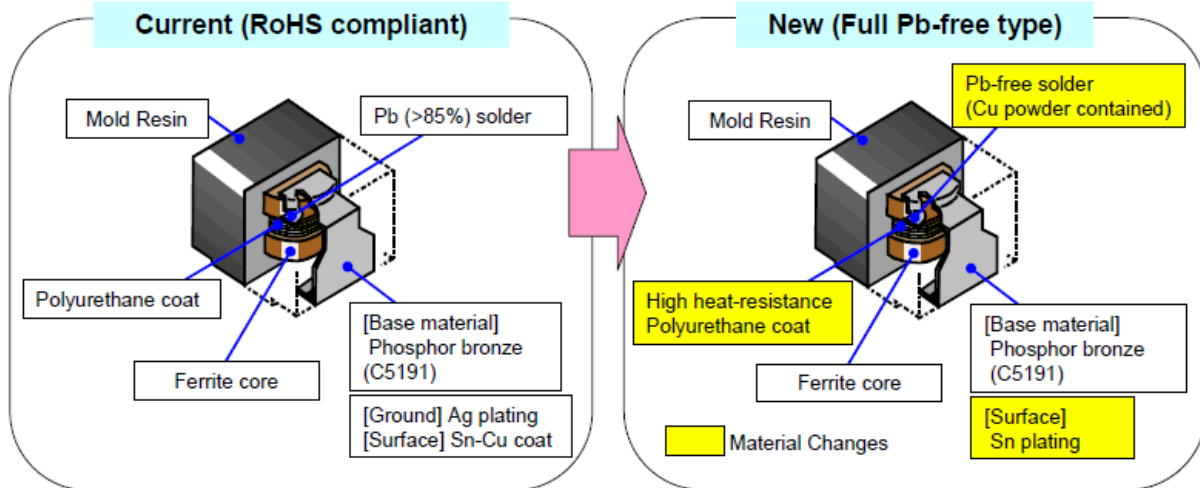
Panasonic, as part of its Green environmental stewardship leadership role, will make a running change, from use of EU RoHS exempt lead (Pb) in high temperature, internal connection solder, to lead-free versions. As an added benefit, reflow temperature capability on the new lead-free product will increase from 250 to 260 degC.

EFFECTIVE DATE:

Ongoing from June 01, 2012.

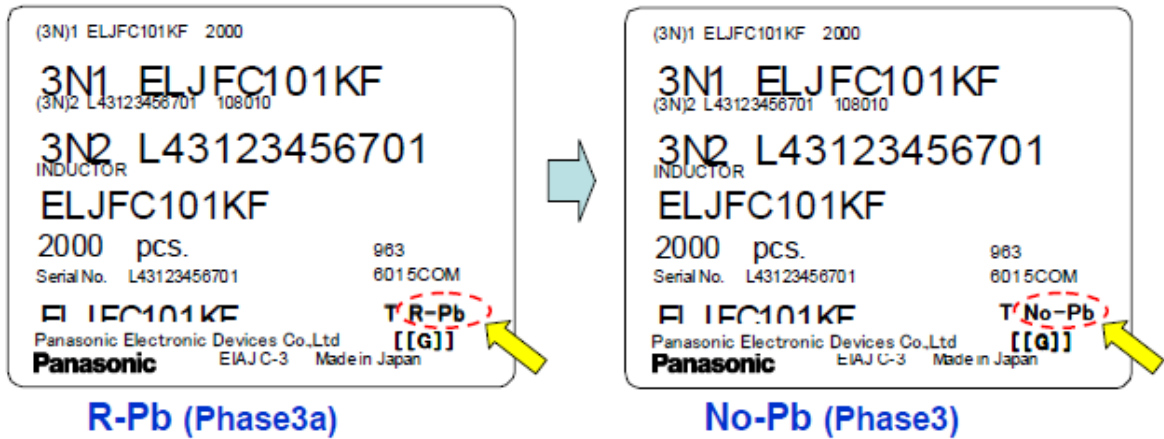
CHANGE DETAILS:

Item	Current product	New product (Full Pb-free type)
Internal Junction Solder	Pb(>85%) Solder	Pb-free Solder (Cu powder contained)
Terminal surface treatment	[Ground] Ag plating [Surface] Sn-0.7Cu coat	Sn plating
Copper wire	Polyurethane coat	High heat-resistance Polyurethane coat
Production Process	-	Terminal solder coating Less



PRODUCT CHANGE NOTICE

Reel face label Identification



AFFECTED PARTS:

- ELJ-xA 1210 Case Size Series
- ELJ-xB 1812 Case Size Series
- ELJ-xC 1008 Case Size Series

DATASHEETS:

<http://industrial.panasonic.com/www-data/pdf/AGA0000/AGA0000CE24.pdf>
<http://industrial.panasonic.com/www-data/pdf/AGA0000/AGA0000CE40.pdf>
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